IPC ASSOCIATION ELECTRONIC		Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute					Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
Supplie	r Information														
ompany	name*	Company un	Company unique ID			Unique ID Authority					Response Date*				
nsemi												2024-05-15			
Contact N	Name	Title - Contact			I	Phone - Contact*					Email - Contact*				
Product-l	Env-Stewards	Product Enviro Compliance			]	NA					Product-Env-Stewards@onsemi.com				
uthorize	ed Representative*	Title - Representative			F	Phone - Representative*				Email - Representative*					
Product-	Env-Stewards	Product Enviro Compliance			1	NA					Product-Env-Stewards@onsemi.com				
	Requester Item Number	Requester Item Number Mfr Item		n Number Mfr Item Name			Effective Date	Date Version Manufacturing Site		ing Site	V	Veight*	UOM	Unit Type	
		NSVG1001MXTAG RF SPDT Switch M		MMIC		2024-05-15		CN1			1	.46	mg	Each	
Ianufa	ecturing Proccess Inform	nation						·						•	
	8		Terminal Base Alloy J-STD		-STD-020 MSL	Rating			y Temperatui	ture Max Time at Peak Tempera		<u>Femperatu</u>	re Numb	er of Reflow Cyc	eles
	Matte Tin (Sn) - annealed	(	CU Alloy	1			260		C	30		second	ls 3		
omments															
vel 1 - m	naximum time at peak temper	ature during so	ldering is 10-3	30 seconds											
or more	information regarding materi	al composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applic											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.102	mg	Supplier	GaAs	1303-00-0		0.0865	mg
			Supplier	Silicon Nitride SiN	12033-60-2		0.0004	mg
			Supplier	Platinum (Pt)	7440-06-4		0.0017	mg
			Supplier	Misc.	Proprietary Data		0.0001	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0003	mg
			Supplier	Gold (Au)	7440-57-5		0.013	mg
Die Attach	0.04	mg	Supplier	Silver (Ag)	7440-22-4		0.03	mg
			Supplier	Epoxy resins	129915-35-1		0.01	mg
Lead Frame	0.709	mg	Supplier	Tin (Sn)	7440-31-5		0.0018	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0016	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0018	mg
			Supplier	Copper (Cu)	7440-50-8		0.7039	mg
Mold Compound-Black	0.512	mg		Epoxy resin	proprietary data		0.0241	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0512	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0005	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.4122	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0241	mg
Plating	0.006	mg	Supplier	Palladium (Pd)	7440-05-3		0.0003	mg
			В	Nickel (Ni)	7440-02-0		0.0056	mg
			Supplier	Gold (Au)	7440-57-5		0.0001	mg
Plating-Sn	0.053	mg	Supplier	Tin (Sn)	7440-31-5		0.053	mg
Wire Bond - Au	0.038	mg	Supplier	Gold (Au)	7440-57-5		0.038	mg